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Kind regards,

Team Nexperia

74LVC541A

Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

Rev. 4 — 25 November 2011

Product data sheet

1. General description

The 74LVC541A is an octal non-inverting buffer/line driver with 5 V tolerant inputs and outputs. The 3-state outputs are controlled by the output enable inputs $\overline{OE}1$ and $\overline{OE}2$.

This device is fully specified for partial power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Inputs can be driven from either 3.3~V or 5~V devices. When disabled, up to 5.5~V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3~V and 5~V applications.

2. Features and benefits

- 5 V tolerant inputs for interlacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - ◆ MM JESD22-A115B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



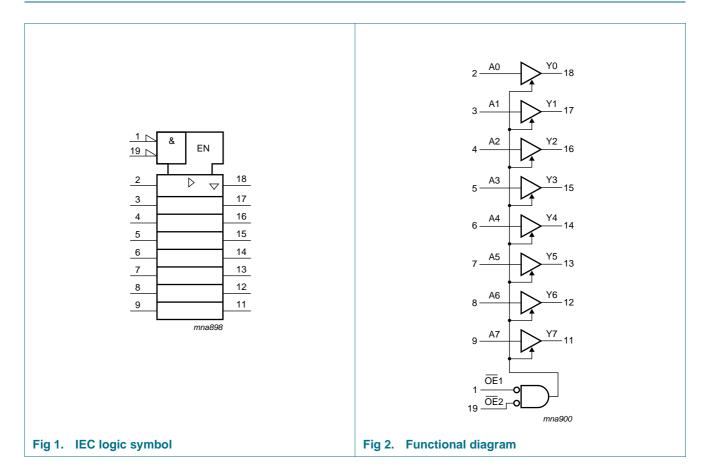
Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC541AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74LVC541ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74LVC541APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74LVC541ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 \times 4.5 \times 0.85 mm	SOT764-1

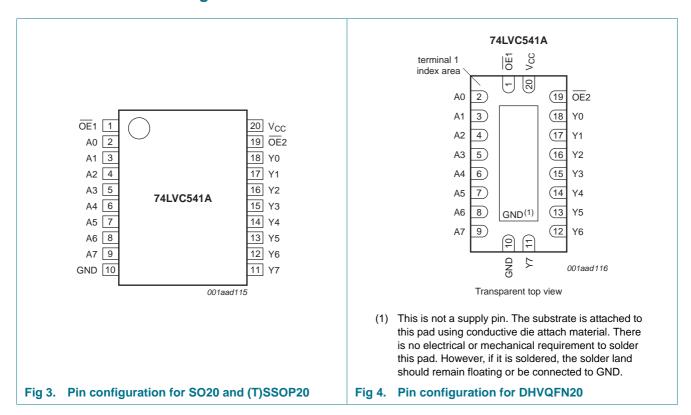
4. Functional diagram



Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

	The second secon	
Symbol	Pin	Description
OE1	1	output enable input (active LOW)
A[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input
GND	10	ground (0 V)
Y[0:7]	18, 17, 16, 15, 14, 13, 12, 11	bus output
OE ₂	19	output enable input (active LOW)
V _{CC}	20	supply voltage

Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

6. Functional description

Table 3. Functional table[1]

Input OE1		Output	
OE1	OE2	An	Yn
L	L	L	L
L	L	Н	Н
X	Н	X	Z
Н	X	X	Z

^[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

Z = high-impedance OFF-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+5.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
V _O	output voltage	output HIGH or LOW state	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state or power-down	<u>[2]</u> –0.5	+6.5	V
I _O	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-60	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	<u>[3]</u> _	500	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SO20 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For (T)SSOP20 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN20 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V_{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV input transition rise and f		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
	rate	V _{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
V_{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V_{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.2	-	-	V _{CC} – 0.3	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V_{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	8.0	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		I_{O} = 24 mA; V_{CC} = 3.0 V	-	-	0.55	-	0.8	V

Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

Table 6. Static characteristics ...continued
At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	5 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
lı	input leakage current	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 3.6 \text{ V}$	-	±0.1	±5	-	±20	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_O = 5.5$ V or GND; $V_{CC} = 3.6$ V	-	±0.1	±5	-	±20	μА
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 5.5 \text{ V}; V_{CC} = 0.0 \text{ V}$	-	±0.1	±10	-	±20	μА
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6 \text{ V}$	-	0.1	10	-	40	μА
ΔI_{CC}	additional supply current	per input pin; $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	5	500	-	5000	μА
C _I	input capacitance		-	5.0	-	-	-	pF

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		-40 '	°C to +8	5 °C	–40 °C to	Unit	
			ı	Min	Typ[1]	Max	Min	Max	
t_{pd}	propagation	An to Yn; see Figure 5	1						
	delay	V _{CC} = 1.2 V		-	14.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	6.5	13.8	1.5	16.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.5	6.8	1.0	7.9	ns
		V _{CC} = 2.7 V		1.5	3.5	5.6	1.5	7.0	ns
		V _{CC} = 3.0 V to 3.6 V		1.0	2.9	5.1	1.0	6.5	ns
t _{en}	enable time	OEn to Yn; see Figure 6]						
		V _{CC} = 1.2 V		-	20.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.8	7.7	16.0	1.8	18.5	ns
		V _{CC} = 2.3 V to 2.7 V		1.5	4.3	8.8	1.5	10.2	ns
		V _{CC} = 2.7 V		1.5	4.4	7.5	1.5	9.5	ns
		V _{CC} = 3.0 V to 3.6 V		1.0	3.5	7.0	1.0	9.0	ns
t_{dis}	disable time	OEn to Yn; see Figure 6]						
		V _{CC} = 1.2 V		-	11.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	;	3.0	4.9	10.3	3.0	11.9	ns
		V _{CC} = 2.3 V to 2.7 V		1.0	2.7	5.9	1.0	6.8	ns
		V _{CC} = 2.7 V		1.5	3.7	7.0	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.3	6.0	1.0	7.5	ns

74LVC541A

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Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
C_PD	power	per input; $V_I = GND$ to V_{CC}	<u>[4]</u>				'	•	
	dissipation capacitance	V _{CC} = 1.65 V to 1.95 V		-	7.7	-	-	-	pF
	capacitarice	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	11.3	-	-	-	pF
	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$			-	14.4	-	-	-	pF

- [1] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.2$ V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.
- $\begin{array}{ll} [2] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}. \\ & t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}. \\ & t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}. \end{array}$
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o) \text{ where:}$

f_i = input frequency in MHz; f_o = output frequency in MHz

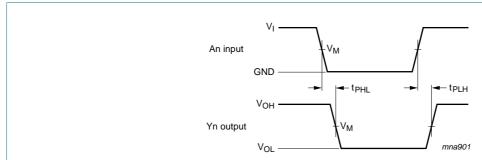
C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs.

11. AC waveforms



 $V_M = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V}.$

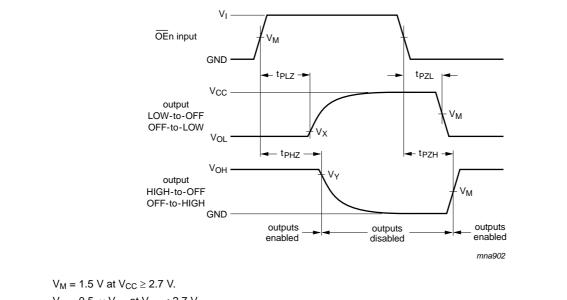
 V_{M} = 0.5 \times V_{CC} at V_{CC} < 2.7 V.

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 5. Input (An) to output (Yn) propagation delays

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Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state



 $V_M = 0.5 \times V_{CC}$ at $V_{CC} < 2.7$ V.

 $V_X = V_{OL} + 0.3 \text{ V at } V_{CC} \ge 2.7 \text{ V};$

 $V_X = V_{OL} + 0.15 \text{ V at } V_{CC} < 2.7 \text{ V};$

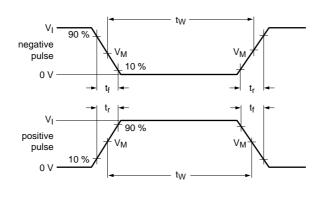
 $V_Y = V_{OH} - 0.3 \text{ V at } V_{CC} \ge 2.7 \text{ V};$

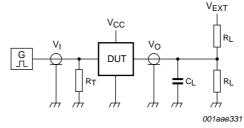
 V_{Y} = $V_{OH} - 0.15 \; V$ at $V_{CC} < 2.7 \; V.$

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 6. 3-state enable and disable times

Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state





Test data is given in Table 8.

Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

Table 8. Test data

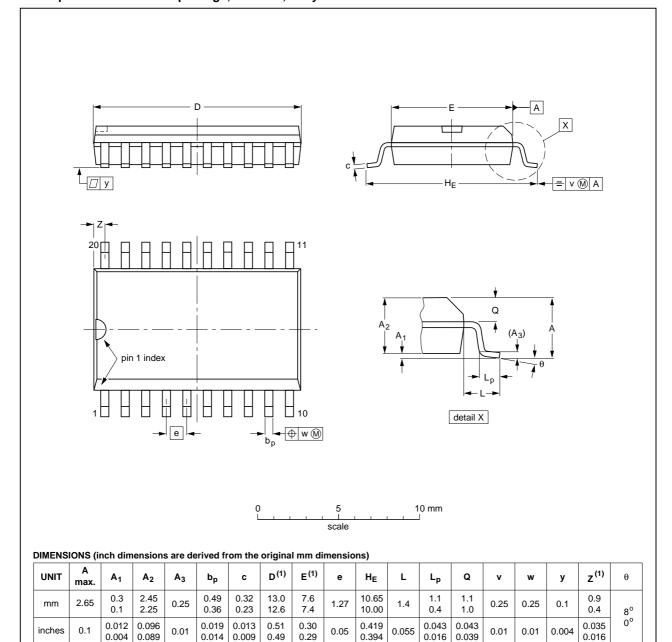
Supply voltage	Input		Load		V _{EXT}	V _{EXT}				
	VI	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t_{PLZ}, t_{PZL}	t _{PHZ} , t _{PZH}			
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 k Ω	open	$2\times V_{CC}$	GND			
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND			
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND			
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND			
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND			

Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013				99-12-27 03-02-19

Fig 8. Package outline SOT163-1 (SO20)

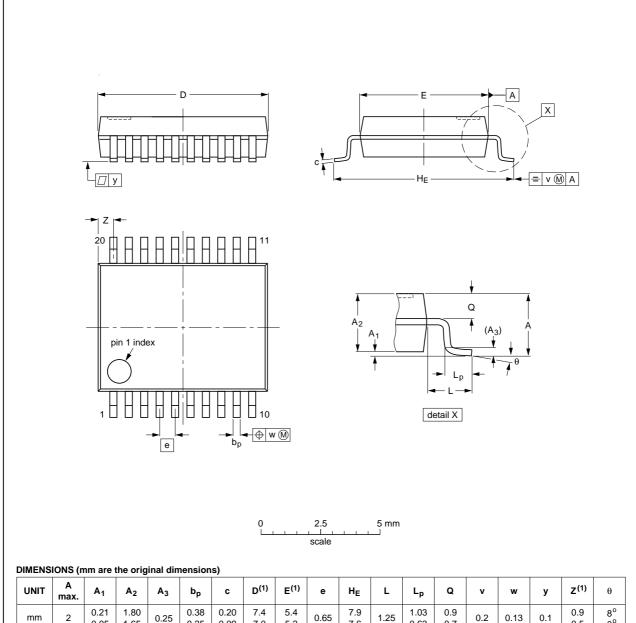
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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT339-1		MO-150				99-12-27 03-02-19

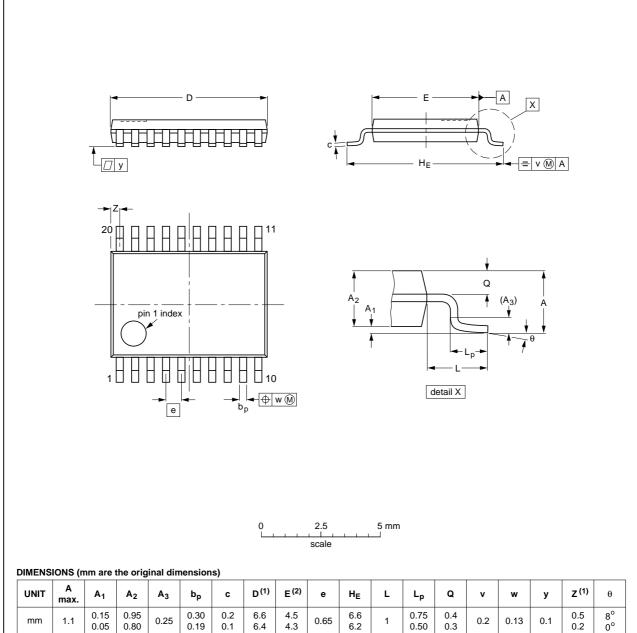
Fig 9. Package outline SOT339-1 (SSOP20)

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Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



NI-4--

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
SOT360-1		MO-153				99-12-27 03-02-19

Fig 10. Package outline SOT360-1 (TSSOP20)

74LVC541A

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Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

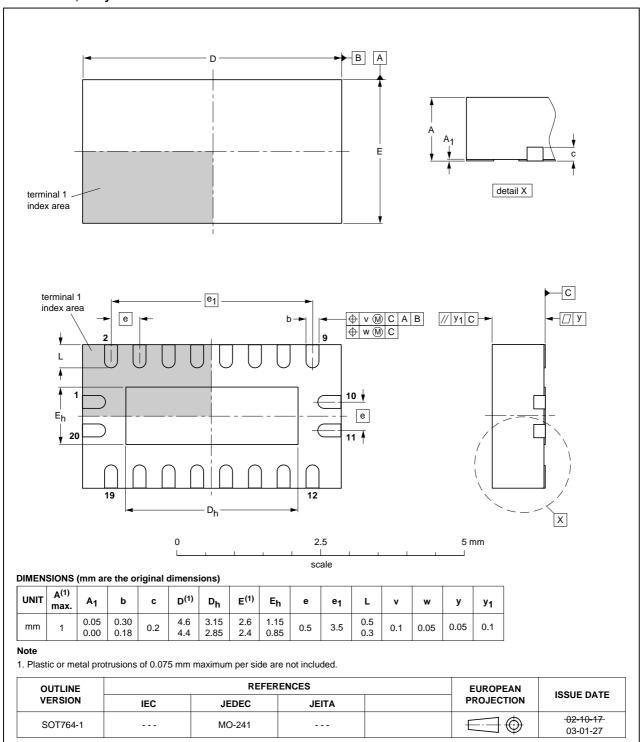


Fig 11. Package outline SOT764-1 (DHVQFN20)

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Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

13. Abbreviations

Table 9. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
MM	Machine Model
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 10. Revision history

	•					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC541A v.4	20111125	Product data sheet	-	74LVC541A v.3		
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal texts have been adapted to the new company name where appropriate. 					
	• <u>Table 4</u> , <u>Table 5</u> , <u>Table 6</u> , <u>Table 7</u> and <u>Table 8</u> : values added for lower voltage ranges.					
74LVC541A v.3	20031112	Product specification	-	74LVC541A v.2		
74LVC541A v.2	20030514	Product specification	-	74LVC541A v.1		
74LVC541A v.1	19980729	Product specification	-	-		

Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

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16. Contact information

For more information, please visit: http://www.nxp.com

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17. Contents

1	General description
2	Features and benefits
3	Ordering information 2
4	Functional diagram 2
5	Pinning information 3
5.1	Pinning
5.2	Pin description
6	Functional description 4
7	Limiting values 4
8	Recommended operating conditions 5
9	Static characteristics 5
10	Dynamic characteristics 6
11	AC waveforms
12	Package outline
13	Abbreviations 14
14	Revision history 14
15	Legal information
15.1	Data sheet status
15.2	Definitions
15.3	Disclaimers
15.4	Trademarks16
16	Contact information 16
17	Contents

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